High Heat Flux Test Facility (HHFTF) at IPR

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High Heat Flux Test Facility (HHFTF) at IPR is one of the few test facilities in the world, designed to perform heat transfer experiments for water cooled components under intense heat load conditions. The facility uses a 200kW(45kV) electron beam as heat source. Pencil Beam (circular cylindrical beam) of electrons having Gaussian radial cross-section in the range $\sigma \approx 4$ -8mm can be rastered along pre-programmed rastering patterns at high frequency of 10kHz so as to generate desired uniform as well as non-unifom heat flux profiles over surface of the component being tested. The beam can be operated at full power either in pulsed mode (rise & fall time ~ 1 ms) or in steady state mode. High Pressure High Temperature Water Circulation System (HPHT-WCS) of HHFTF is capable of supplying coolant water to components at maximum flow parameters of 160C temperature, 60bar pressure and 300 lpm flow rate. D-shaped double walled vacuum chamber of volume $\sim 5m^3$ having several diagnostic and vacuum pumping ports, is evacuated using combination of turbo molecular pump and cryo-sorption pump so as to generate controlled background operating pressure in the range of 10⁻⁶bar to 10⁻⁴bar. Vacuum chamber is designed to attenuate X-rays emitted during experiments within allowed safe limits. HHFTF is approved by AERB for radiation safety. HHFTF can be used for testing big sized vacuum compatible and water cooled components with heat receiving area of 1m x Im and weighing up to 1 ton. The facility is routinely being used to perform thermal hydraulic heat transfer experiments on plasma facing components and test mock ups for incident heat flux of the order of 10MW/m² under vacuum conditions.



200kW Electron gun horizontally mounted on vacuum chamber of HHFTF



Inside view of target handling system used to mount the test job



High Pressure High Temperature Water Circulation System (60 bar,160C, 300 lpm)

High Heat flux testing of test mockups with 500 µm thick W coating on CuCrZr/ SS316/ RAFMS water cooled substrates. W coating maintained ~500C for 1000 thermal cycles of duration 30-45 sec ON time and 15-30 Sec OFF time.

High Heat Flux testing performed HHFTF on mono- blocks diffusion bonded to CuCrZr tube passing through centre. Thermal cyclic testing of these mock ups successfully out for heat flux up to 20MW/m².



Tungsten coated Stainless Steel test



IR image of mock-up surface with spatial mock-up (30x30mm²) resolution of ~2 x2 mm²



IR Image showing uniform heat flux over 30x30 mm² surface



Average surface temp. in four adjacent regions by IR camera



Surafce 600

400

200

20

80 100 120

Surface Temp. using One Color Fast Pyrometer

in central region of 10mm diameter

60

density of ~ 1 MJ/m² with pulse duration 20ms ON & 1000ms OFF. Beam with Gaussian cross-section is focused at centre of the 25mm diameter 5mm thick circular disc specimen made from three tungsten materials. Surface monitored using Fast Pyrometer



temp. Pure Tungsten (W; W-P) & Tungsten+1wt.% La₂O₃ (WL)

DIAGNOSTICS DEVICE SPECIFICATIONS

Thermocouples:

k type unarounded (0°C - 1200°C). 1 mm diameter.



One color pyrometer KLEIBER KMGA 740 LO:

Temp Range:350°C- 3500°C, sampling rate:10µsec Spectral range: 2.0 ... 2.5 µm



IMPAC Two color pyrometer IGAR12-LO (MB13) :

Temp. Range:350°C-1000°C Sampling rate:2 millisec Spectral range:1.52 µm /1.64 µm



IMPAC Two color pyrometer ISR12 -LO (MB33) : Temp. Range:1000°C-3000°C,

Sampling rate:2 millisec Spectral range: 0.8 µm /1.05 µm



FLIR SC 5200 IR camera:

Temp Range: RT- 1500°C, 2 - 1000 Fps, Framerate:320x 256/160 x 128 / 64 x 8 pixels Temperature measurement accuracy: ±1 °C or ±1%

FLIR SC 5200MB IR camera:

Temp Range: RT -500, 1000 - 3000°C, 2 - 1000 Fps, Frame Size:320x 256/160 x 128/64 x 8 pixels Temperature measurement accuracy: ±1 °C or ±1%

Data Acquisition & Control System for HHFTF

- 1. PXI based Real time data acquisition & control and PLC based sequential control provide automation of entire operation of HHFTF.
- 2. Effective user control with fast safety interlocks.
- 3. Real time control loop with loop time 20µs 200µs for fast control and 10-100ms for slow control.
- Total 112 channels for data acquisition & control. 4.
- 5. Adjustable sampling rate from 90 Sample/s to 750 kiloSample/s per channel.
- 6. Acquisition of different selected parameters, online display of selected channel and offline analysis facility.
- 7. User administration and Access control.
- 8. Comprehensive GUI for visualization.
- 9. Data storage in TDMS format for pre/post processing.

Engineering/Data Analysis for HHFTF

Engineering Analysis and Computational Fluid Dynamic Simulations for heat transfer, Simulation of Experiments and Data Analysis of experiments using HHFTF are performed using standard available software such as - ANSYS, STAR CCM+, COMSOL, MATLAB.

Coolant calorimetry:

Fast Response RTD Pt 100, 4 mm diameter, 3 - Wire Response less than 1 sec

Mass Analyzer:

Residual Gas Analyzer up to 300AMU

Photron High Speed Imagining camera

Monochrome CMOS sensor 1,280 x 1,024 pixels @ 2,000 fps 640 x 240 pixels @ 10,000fps 12-bit Dynamic Range

Acoustics sensors for CHF detection (upcoming) Frequency Bandwidth: 5Hz to 300KHz



Portalok 7s Ultrasonic flow meter: Range:0.01...25 m/s

Repeatability0.25% of reading +/- 0.02 m/s

BIDIRECTIONAL CURRENT TRANSDUCER SERIES S273:

VOLTAGE SIGNAL: 0 to ±5Vdc FS (Full Scale), ACCURACY: 1% FS



Safety Devices: X-ray Dosimeter, X-ray Area Monitor Accuracy: nSv/h

CALIBATION FACILITIES

M390 Cavity Black body:

Range:500- 3000°C, Accuracy: ±0.25% of reading ±1°C Stability: ±1°C Uniformity: ± 0.1°C



Pagasus Plus 1200 thermocouple calibrator:

Range: 150- 1200°C. Stability-±0.05 – 0.2°C

Probable Usage of HHFTF

- (1) Experimental validation of the design and engineering of the water cooled components for heat transfer.
- (2) Study of damage in various materials caused by intense surface heat loads.
- (3) Study of thermal fatigue life time of single/multilayered structures at high temperature gradients.
- (4) Development and study of technological processes such as high-speed brazing, vacuum casting of metals, heat treatment.

Potential Users of HHFTF

- Organizations working in the field fusion technologies for (1)plasma facing components.
- (2) Research organizations working in the field of heat transfer studies using high pressure high temperature water.
- (3) Industries working for design, development and testing of vacuum compatible water cooled heat transfer components.

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